

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	JUN ZHOU	11/29/2016
	QIKUN LI	11/29/2016
	HUFU XIAO	11/29/2016
	JIANYONG DING	11/29/2016
	CHEN DENG	11/29/2016
	ZHI LI	11/29/2016
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	NANJING INSTITUTE OF ADVANCED LASER TECHNOLOGY	
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<b>City:</b>	NANJING	
<b>State/Country:</b>	CHINA	
<b>Postal Code:</b>	210038	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	15370728
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>		
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<b>ATTORNEY DOCKET NUMBER:</b>	161107-132WT	
<b>NAME OF SUBMITTER:</b>	YUNGPING CHIANG	
<b>SIGNATURE:</b>	/yungping chiang/	
<b>DATE SIGNED:</b>	12/06/2016	

**Total Attachments: 3**

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# ASSIGNMENT OF APPLICATION

Whereas, We, Jun ZHOU; Qikun LI; Hufu XIAO; Jianyong DING; Chen DENG and Zhi LI, hereafter referred to as "APPLICANTS/ASSIGNORS", have invented certain new and useful improvements disclosed, shown, and described in the Chinese application No. CN201510955249.2 which is entitled "High-Power Laser Attenuator"; and

Whereas, Nanjing Institute of Advanced Laser Technology having an office at Bldg A, Longgang Sci and Tech Park, Hengyuan Rd, Nanjing Eco and Tech Develop Zone, Nanjing, Jiangsu 210038 (CN), hereafter referred to "ASSIGNEE", is desirous of acquiring the entire right, title and interest in and to the above identified application and all patents to be obtained therefore in the United States of America;

Now therefore, for good and valuable consideration, we, the APPLICANTS/ASSIGNORS, do assign and transfer to said ASSIGNEE the full and exclusive right to the said application in the United States and the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and behalf, and for its legal representative, successors, and assigns, to the full end of the term for which said patent may be granted as fully and entirely as the same would have been held by us had this assignment not been made.

We, the APPLICANTS/ASSIGNORS, covenant not to have executed and will not execute any agreement in conflict with this assignment.

Date (日期): 2016.11.29

Signature (签字):

Name (姓名): Jun ZHOU

Citizenship: People's Republic of China (CN)

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Name (姓名): Qikun LI

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US Application No.:

Docket No.: 151107-132W7

Date (日期): 2016.11.29

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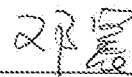
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Date (日期): 2016.11.29

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